FORM PTO-1595 (Rev. 6-93)

WA01A/24265.1

08-21-2000



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MM 7.21.00	Attorney Docket No.: 040894-5559	
To the Commissioner for Patents: Please record the attached original documents or copy thereof.	ATTN: BOX ASSIGNMENT	
1. Name of conveying party(ies):	2. Name and address of receiving party(ies):	
Noboru ISHIKAWA Osamu ITAGAKI	Name: MAX CO., LTD.	
Additional name(s) of conveying party(ies) attached? Yes _X_ No	Internal Address:	
3. Nature of conveyance:	Street Address: 6-6, Nihonbashi Hakozaki-cho, Chuo-ku, Tokyo, Japan City: State: Zip:	
X Assignment Merger Security Agreement Change of Name Other		
Execution Date: July 17, 2000	Additional name(s) & address(es) attached? Yes _X_ No	
4. Application number(s) or patent number(s): If this document is being filed together with a new application the execution date of the application is:		
5. Name and address of party to whom correspondence concerning document should be mailed:	6. Total number of applications and patents involved: 1	
Name: J. Michael Thesz Internal Address: Morgan, Lewis & Bockius LLP Customer No. 009629	7. Total fee (37 C.F.R §3.41):\$40.00_ X. Enclosed Authorized to be charged to deposit account 50-0310	
Street Address: 1800 M Street, N.W. City: Washington State: D.C. Zip: 20036	Deposit account number: 50-0310 Attach duplicate of page if paying by deposit account	
9. Statement and Signature To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document. J. Michael Thesz Name of Person Signing Signature July 21, 2000 Date		
/21/2000 JJALLAH2 00000008 0%24140 Total number of pages including cover sheet, attachments and documents: 2		
FC:581 40.00 09		

PATENT REEL: 011001 FRAME: 0916

ASSIGNMENT

WHEREAS I/We, the below named inventor(s entitled: BINDING MACHINE FOR F), have made an invention
for which I/WE executed an application for United States Letters Patent concurrently herewith; or on; or filed an application for United States Letters Patent on, (Serial No); and		
a corporation of Japan	, whose post office	address is
WHEREAS, MAX Co., LTD. a corporation of Japan , whose post office address is 6-6, Nihonbashi Hakozaki-cho, Chuo-ku, Tokyo, Japan (hereinafter referred to as Assignee),		
is desirous of securing the entire right, title, and interest in and to this invention, the application for United States Letters Patent on this invention and the Letters Patent to be issue upon this application;		
invention and this application, and all divisions, and continuations thereof, and all Letters Patent of the United States which may be granted thereon, and all reissues thereof; and I/WE hereby authorize and request the Commissioner of Patents and Trademarks of the United States to issue all Letters Patent for this invention to assignee, its successors and assigns, in accordance with the terms of this Assignment; AND, I/WE HEREBY further covenant and agree that I/WE will, without further consideration, communicate with assignee, its successors and assigns, any facts known to ME/US respecting this invention and testify in any legal proceeding, sign all lawful papers when called upon to do so, execute and deliver all papers that may be necessary or desirable to perfect the title to this invention in said assignee, its successors and assigns, execute all divisional, continuation, and reissue applications, make all rightful oaths and generally do everything possible to aid assignee, its successors and assigns, to obtain and enforce proper patent protection for this invention in the United States, it being understood that any expense incident to		
the execution of such papers shall be borne by the assignee, its successors and assigns.		
AND, I/WE HEREBY authorize and request the attorneys I/WE have empowered in the Declaration and Power of Attorney in this application, to insert here in parentheses (Application No, filed July 21,2000) the filing date and application number of said application when known.		
IN TESTIMONY WHEREOF, I/WE have hereunto set our hand(s).		
Full Name of Sole of First Assignor Noboru ISHIKAWA	Assignor's Signature Noboru Ishikawa	Date July 17, 2000
Address Tokyo, Japan		Citizenship Japan
2. Full Name of Second Assignor Osamu ITAGAKI	Assignor's Signature Osamu Itagaki	Date July 17, 2000

MORGAN, LEWIS & BOCKIUS

PATENT REEL: 011001 FRAME: 0917

Citizenship

Japan

RECORDED: 07/21/2000

Address

Tokyo, Japan